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Details

Product Status	Obsolete
Core Processor	PIC
Core Size	8-Bit
Speed	16MHz
Connectivity	UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	33
Program Memory Size	8KB (4K x 16)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	454 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 6V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	44-QFP
Supplier Device Package	44-MQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic17c43-16e-pq

4.0 RESET

The PIC17CXX differentiates between various kinds of reset:

- Power-on Reset (POR)
- $\overline{\text{MCLR}}$ reset during normal operation
- WDT Reset (normal operation)

Some registers are not affected in any reset condition; their status is unknown on POR and unchanged in any other reset. Most other registers are forced to a "reset state" on Power-on Reset (POR), on $\overline{\text{MCLR}}$ or WDT Reset and on $\overline{\text{MCLR}}$ reset during SLEEP. They are not affected by a WDT Reset during SLEEP, since this reset is viewed as the resumption of normal operation. The $\overline{\text{TO}}$ and $\overline{\text{PD}}$ bits are set or cleared differently in different reset situations as indicated in Table 4-3. These bits are used in software to determine the nature of reset. See Table 4-4 for a full description of reset states of all registers.

Note: While the device is in a reset state, the internal phase clock is held in the Q1 state. Any processor mode that allows external execution will force the RE0/ALE pin as a low output and the RE1/ $\overline{\text{OE}}$ and RE2/ $\overline{\text{WR}}$ pins as high outputs.

A simplified block diagram of the on-chip reset circuit is shown in Figure 4-1.

4.1 Power-on Reset (POR), Power-up Timer (PWRT), and Oscillator Start-up Timer (OST)

4.1.1 POWER-ON RESET (POR)

The Power-on Reset circuit holds the device in reset until V_{DD} is above the trip point (in the range of 1.4V - 2.3V). The PIC17C42 does not produce an internal reset when V_{DD} declines. All other devices will produce an internal reset for both rising and falling V_{DD} . To take advantage of the POR, just tie the $\overline{\text{MCLR}}/\text{VPP}$ pin directly (or through a resistor) to V_{DD} . This will eliminate external RC components usually needed to create Power-on Reset. A minimum rise time for V_{DD} is required. See Electrical Specifications for details.

4.1.2 POWER-UP TIMER (PWRT)

The Power-up Timer provides a fixed 96 ms time-out (nominal) on power-up. This occurs from rising edge of the POR signal and after the first rising edge of $\overline{\text{MCLR}}$ (detected high). The Power-up Timer operates on an internal RC oscillator. The chip is kept in RESET as long as the PWRT is active. In most cases the PWRT delay allows the V_{DD} to rise to an acceptable level.

The power-up time delay will vary from chip to chip and to V_{DD} and temperature. See DC parameters for details.

FIGURE 4-1: SIMPLIFIED BLOCK DIAGRAM OF ON-CHIP RESET CIRCUIT

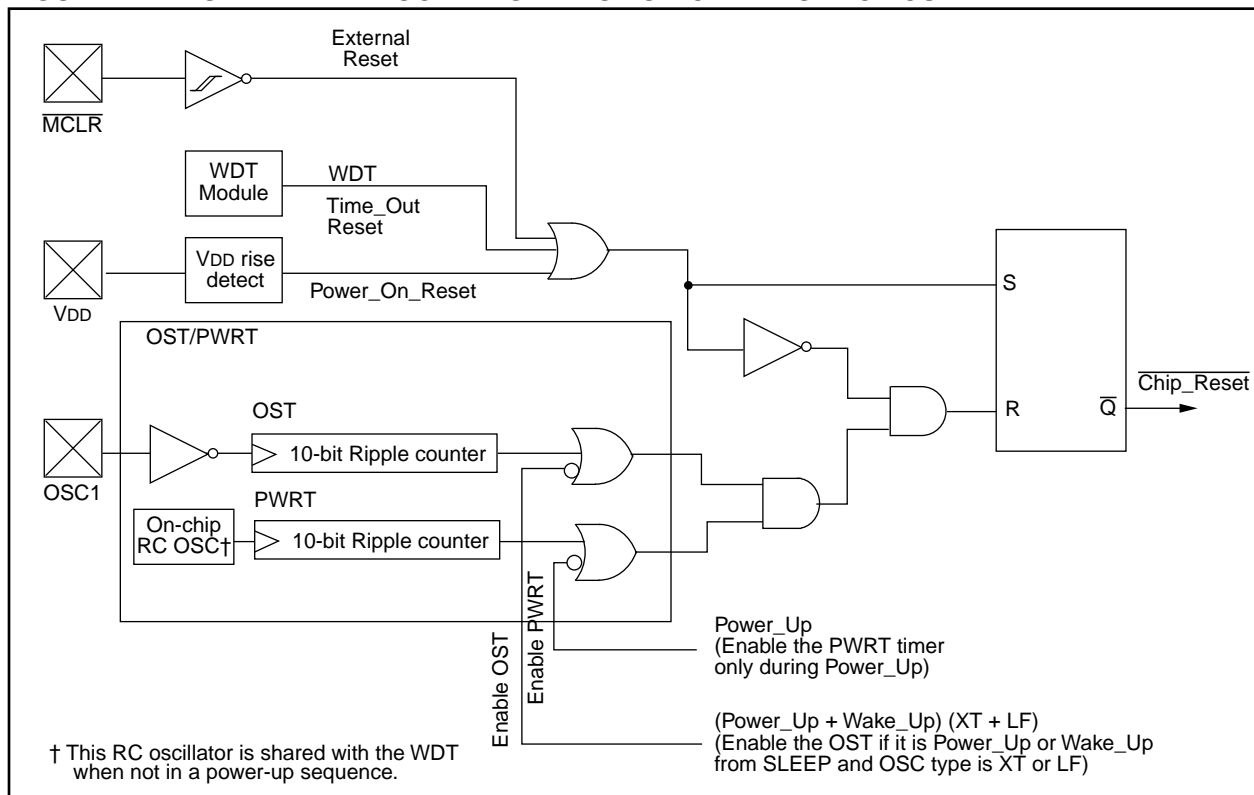


TABLE 6-3: SPECIAL FUNCTION REGISTERS

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-on Reset	Value on all other resets (3)
Unbanked											
00h	INDF0	Uses contents of FSR0 to address data memory (not a physical register)								---- --	---- --
01h	FSR0	Indirect data memory address pointer 0								xxxx xxxx	uuuu uuuu
02h	PCL	Low order 8-bits of PC								0000 0000	0000 0000
03h ⁽¹⁾	PCLATH	Holding register for upper 8-bits of PC								0000 0000	uuuu uuuu
04h	ALUSTA	FS3	FS2	FS1	FS0	OV	Z	DC	C	1111 xxxx	1111 uuuu
05h	T0STA	INTEDG	T0SE	T0CS	PS3	PS2	PS1	PS0	—	0000 000-	0000 000-
06h ⁽²⁾	CPUSTA	—	—	STKAV	GLINTD	T0	PD	—	—	--11 11--	--11 qq--
07h	INTSTA	PEIF	T0CKIF	T0IF	INTF	PEIE	T0CKIE	T0IE	INTE	0000 0000	0000 0000
08h	INDF1	Uses contents of FSR1 to address data memory (not a physical register)								---- --	---- --
09h	FSR1	Indirect data memory address pointer 1								xxxx xxxx	uuuu uuuu
0Ah	WREG	Working register								xxxx xxxx	uuuu uuuu
0Bh	TMR0L	TMR0 register; low byte								xxxx xxxx	uuuu uuuu
0Ch	TMR0H	TMR0 register; high byte								xxxx xxxx	uuuu uuuu
0Dh	TBLPTRL	Low byte of program memory table pointer								(4)	(4)
0Eh	TBLPTRH	High byte of program memory table pointer								(4)	(4)
0Fh	BSR	Bank select register								0000 0000	0000 0000
Bank 0											
10h	PORTA	RBP0	—	RA5	RA4	RA3	RA2	RA1/T0CKI	RA0/INT	0-xx xxxx	0-uu uuuu
11h	DDRB	Data direction register for PORTB								1111 1111	1111 1111
12h	PORTB	PORTB data latch								xxxx xxxx	uuuu uuuu
13h	RCSTA	SPEN	RX9	SREN	CREN	—	FERR	OERR	RX9D	0000 -00x	0000 -00u
14h	RCREG	Serial port receive register								xxxx xxxx	uuuu uuuu
15h	TXSTA	CSRC	TX9	TXEN	SYNC	—	—	TRMT	TX9D	0000 --1x	0000 --1u
16h	TXREG	Serial port transmit register								xxxx xxxx	uuuu uuuu
17h	SPBRG	Baud rate generator register								xxxx xxxx	uuuu uuuu
Bank 1											
10h	DDRC	Data direction register for PORTC								1111 1111	1111 1111
11h	PORTC	RC7/AD7	RC6/AD6	RC5/AD5	RC4/AD4	RC3/AD3	RC2/AD2	RC1/AD1	RC0/AD0	xxxx xxxx	uuuu uuuu
12h	DDRD	Data direction register for PORTD								1111 1111	1111 1111
13h	PORTD	RD7/AD15	RD6/AD14	RD5/AD13	RD4/AD12	RD3/AD11	RD2/AD10	RD1/AD9	RD0/AD8	xxxx xxxx	uuuu uuuu
14h	DDRE	Data direction register for PORTE								---- -111	---- -111
15h	PORTE	—	—	—	—	—	RE2/W _R	RE1/O _E	RE0/ALE	---- -xxx	---- -uuu
16h	PIR	RBIF	TMR3IF	TMR2IF	TMR1IF	CA2IF	CA1IF	TXIF	RCIF	0000 0010	0000 0010
17h	PIE	RBIE	TMR3IE	TMR2IE	TMR1IE	CA2IE	CA1IE	TXIE	RCIE	0000 0000	0000 0000

Legend: x = unknown, u = unchanged, - = unimplemented read as '0', q - value depends on condition. Shaded cells are unimplemented, read as '0'.

Note 1: The upper byte of the program counter is not directly accessible. PCLATH is a holding register for PC<15:8> whose contents are updated from or transferred to the upper byte of the program counter.

2: The T0 and PD status bits in CPUSTA are not affected by a MCLR reset.

3: Other (non power-up) resets include: external reset through MCLR and the Watchdog Timer Reset.

4: The following values are for both TBLPTRL and TBLPTRH:

All PIC17C4X devices (Power-on Reset 0000 0000) and (All other resets 0000 0000) except the PIC17C42 (Power-on Reset xxxx xxxx) and (All other resets uuuu uuuu)

5: The PRODL and PRODH registers are not implemented on the PIC17C42.

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6.2.2.3 TMR0 STATUS/CONTROL REGISTER (T0STA)

This register contains various control bits. Bit7 (INTEDG) is used to control the edge upon which a signal on the RA0/INT pin will set the RB0/INT interrupt flag. The other bits configure the Timer0 prescaler and clock source. (Figure 11-1).

FIGURE 6-9: T0STA REGISTER (ADDRESS: 05h, UNBANKED)

R/W - 0	R/W - 0	R/W - 0	R/W - 0	R/W - 0	R/W - 0	R/W - 0	U - 0
INTEDG	T0SE	T0CS	PS3	PS2	PS1	PS0	—
bit7							bit0

R = Readable bit
W = Writable bit
U = Unimplemented, reads as '0'
-n = Value at POR reset

bit 7: **INTEDG:** RA0/INT Pin Interrupt Edge Select bit
This bit selects the edge upon which the interrupt is detected.
1 = Rising edge of RA0/INT pin generates interrupt
0 = Falling edge of RA0/INT pin generates interrupt

bit 6: **T0SE:** Timer0 Clock Input Edge Select bit
This bit selects the edge upon which TMR0 will increment.
When T0CS = 0
1 = Rising edge of RA1/T0CKI pin increments TMR0 and/or generates a T0CKIF interrupt
0 = Falling edge of RA1/T0CKI pin increments TMR0 and/or generates a T0CKIF interrupt
When T0CS = 1
Don't care

bit 5: **T0CS:** Timer0 Clock Source Select bit
This bit selects the clock source for Timer0.
1 = Internal instruction clock cycle (TCY)
0 = T0CKI pin

bit 4-1: **PS3:PS0:** Timer0 Prescale Selection bits
These bits select the prescale value for Timer0.

PS3:PS0	Prescale Value
0000	1:1
0001	1:2
0010	1:4
0011	1:8
0100	1:16
0101	1:32
0110	1:64
0111	1:128
1xxx	1:256

bit 0: **Unimplemented:** Read as '0'

6.4.1 INDIRECT ADDRESSING REGISTERS

The PIC17C4X has four registers for indirect addressing. These registers are:

- INDF0 and FSR0
- INDF1 and FSR1

Registers INDF0 and INDF1 are not physically implemented. Reading or writing to these registers activates indirect addressing, with the value in the corresponding FSR register being the address of the data. The FSR is an 8-bit register and allows addressing anywhere in the 256-byte data memory address range. For banked memory, the bank of memory accessed is specified by the value in the BSR.

If file INDF0 (or INDF1) itself is read indirectly via an FSR, all '0's are read (Zero bit is set). Similarly, if INDF0 (or INDF1) is written to indirectly, the operation will be equivalent to a NOP, and the status bits are not affected.

6.4.2 INDIRECT ADDRESSING OPERATION

The indirect addressing capability has been enhanced over that of the PIC16CXX family. There are two control bits associated with each FSR register. These two bits configure the FSR register to:

- Auto-decrement the value (address) in the FSR after an indirect access
- Auto-increment the value (address) in the FSR after an indirect access
- No change to the value (address) in the FSR after an indirect access

These control bits are located in the ALUSTA register. The FSR1 register is controlled by the FS3:FS2 bits and FSR0 is controlled by the FS1:FS0 bits.

When using the auto-increment or auto-decrement features, the effect on the FSR is not reflected in the ALUSTA register. For example, if the indirect address causes the FSR to equal '0', the Z bit will not be set.

If the FSR register contains a value of 0h, an indirect read will read 0h (Zero bit is set) while an indirect write will be equivalent to a NOP (status bits are not affected).

Indirect addressing allows single cycle data transfers within the entire data space. This is possible with the use of the MOVPPF and MOVFP instructions, where either 'p' or 'f' is specified as INDF0 (or INDF1).

If the source or destination of the indirect address is in banked memory, the location accessed will be determined by the value in the BSR.

A simple program to clear RAM from 20h - FFh is shown in Example 6-1.

EXAMPLE 6-1: INDIRECT ADDRESSING

```
MOVLW    0x20      ;
MOVWF    FSR0      ; FSR0 = 20h
BCF      ALUSTA, FS1 ; Increment FSR
BSF      ALUSTA, FS0 ; after access
BCF      ALUSTA, C   ; C = 0
MOVLW    END_RAM + 1 ;
LP CLRf    INDF0      ; Addr(FSR) = 0
CPFSEQ   FSR0        ; FSR0 = END_RAM+1?
GOTO     LP          ; NO, clear next
:         ; YES, All RAM is
:         ; cleared
```

6.5 Table Pointer (TBLPTRL and TBLPTRH)

File registers TBLPTRL and TBLPTRH form a 16-bit pointer to address the 64K program memory space. The table pointer is used by instructions TABLWT and TABLRD.

The TABLRD and the TABLWT instructions allow transfer of data between program and data space. The table pointer serves as the 16-bit address of the data word within the program memory. For a more complete description of these registers and the operation of Table Reads and Table Writes, see Section 7.0.

6.6 Table Latch (TBLATH, TBLATL)

The table latch (TBLAT) is a 16-bit register, with TBLATH and TBLATL referring to the high and low bytes of the register. It is not mapped into data or program memory. The table latch is used as a temporary holding latch during data transfer between program and data memory (see descriptions of instructions TABLRD, TABLWT, TLRD and TLWT). For a more complete description of these registers and the operation of Table Reads and Table Writes, see Section 7.0.

7.0 TABLE READS AND TABLE WRITES

The PIC17C4X has four instructions that allow the processor to move data from the data memory space to the program memory space, and vice versa. Since the program memory space is 16-bits wide and the data memory space is 8-bits wide, two operations are required to move 16-bit values to/from the data memory.

The `TLWT t,f` and `TABLWT t,i,f` instructions are used to write data from the data memory space to the program memory space. The `TLRD t,f` and `TABLRD t,i,f` instructions are used to write data from the program memory space to the data memory space.

The program memory can be internal or external. For the program memory access to be external, the device needs to be operating in extended microcontroller or microprocessor mode.

Figure 7-1 through Figure 7-4 show the operation of these four instructions.

FIGURE 7-1: TLWT INSTRUCTION OPERATION

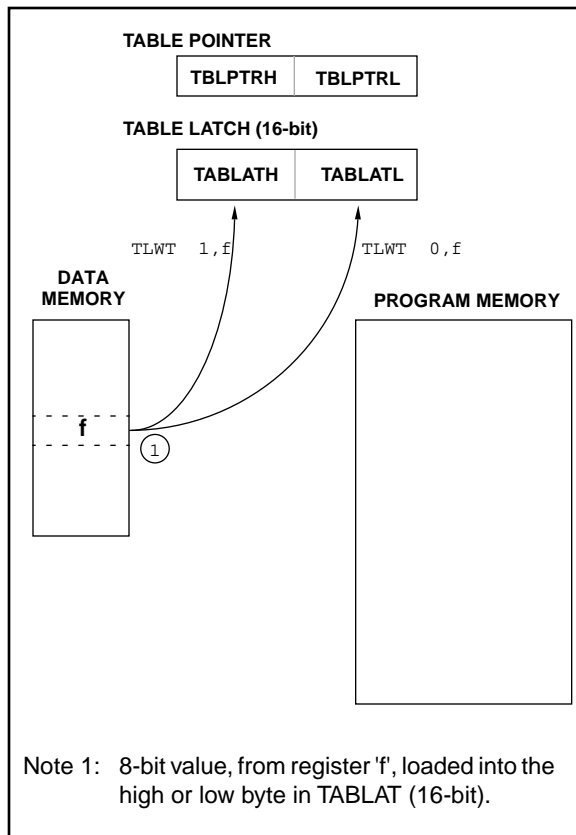


FIGURE 7-2: TABLWT INSTRUCTION OPERATION

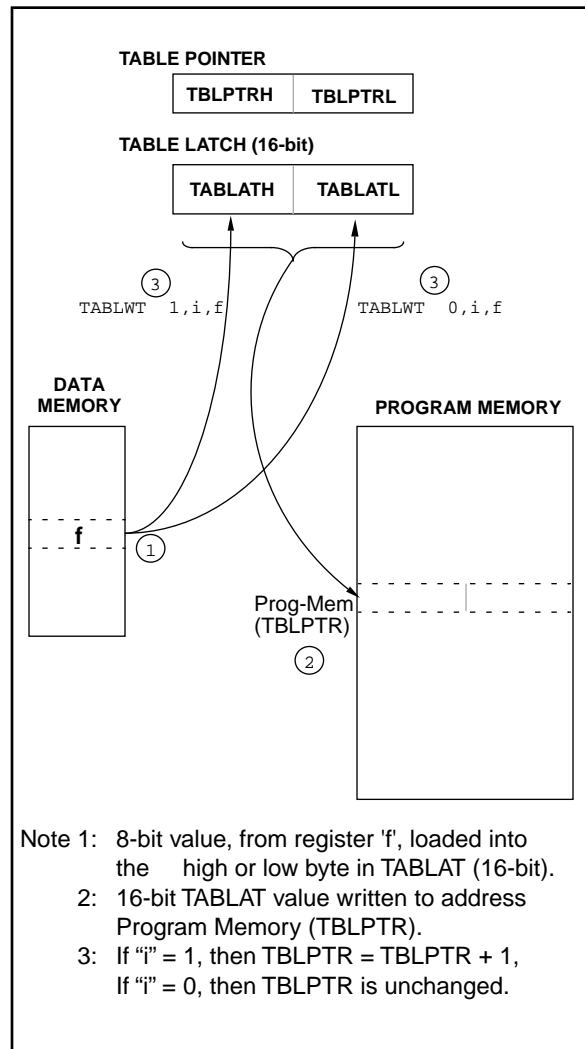


FIGURE 9-2: RA2 AND RA3 BLOCK DIAGRAM

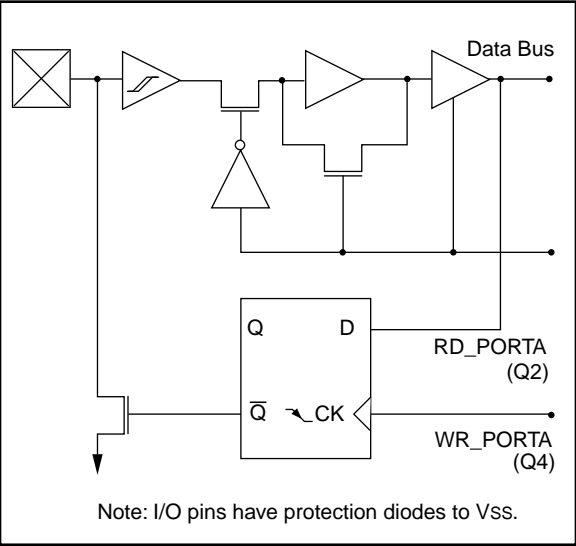


FIGURE 9-3: RA4 AND RA5 BLOCK DIAGRAM

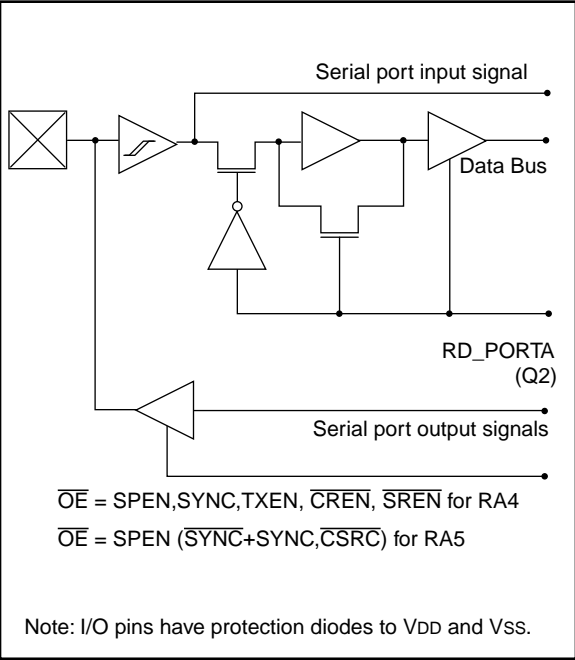


TABLE 9-1: PORTA FUNCTIONS

Name	Bit0	Buffer Type	Function
RA0/INT	bit0	ST	Input or external interrupt input.
RA1/T0CKI	bit1	ST	Input or clock input to the TMR0 timer/counter, and/or an external interrupt input.
RA2	bit2	ST	Input/Output. Output is open drain type.
RA3	bit3	ST	Input/Output. Output is open drain type.
RA4/RX/DT	bit4	ST	Input or USART Asynchronous Receive or USART Synchronous Data.
RA5/TX/CK	bit5	ST	Input or USART Asynchronous Transmit or USART Synchronous Clock.
RBPƯ	bit7	—	Control bit for PORTB weak pull-ups.

Legend: ST = Schmitt Trigger input.

TABLE 9-2: REGISTERS/BITS ASSOCIATED WITH PORTA

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-on Reset	Value on all other resets (Note1)
10h, Bank 0	PORTA	RBPƯ	—	RA5	RA4	RA3	RA2	RA1/T0CKI	RA0/INT	0-xx xxxx	0-uu uuuu
05h, Unbanked	T0STA	INTEDG	T0SE	T0CS	PS3	PS2	PS1	PS0	—	0000 000-	0000 000-
13h, Bank 0	RCSTA	SPEN	RC9	SREN	CREN	—	FERR	OERR	RC9D	0000 -00x	0000 -00u
15h, Bank 0	TXSTA	CSRC	TX9	TXEN	SYNC	—	—	TRMT	TX9D	0000 --1x	0000 --1u

Legend: x = unknown, u = unchanged, - = unimplemented reads as '0'. Shaded cells are not used by PORTA.

Note 1: Other (non power-up) resets include: external reset through MCLR and the Watchdog Timer Reset.

11.1 Timer0 Operation

When the T0CS (T0STA<5>) bit is set, TMR0 increments on the internal clock. When T0CS is clear, TMR0 increments on the external clock (RA1/T0CKI pin). The external clock edge can be configured in software. When the T0SE (T0STA<6>) bit is set, the timer will increment on the rising edge of the RA1/T0CKI pin. When T0SE is clear, the timer will increment on the falling edge of the RA1/T0CKI pin. The prescaler can be programmed to introduce a prescale of 1:1 to 1:256. The timer increments from 0000h to FFFFh and rolls over to 0000h. On overflow, the TMR0 Interrupt Flag bit (T0IF) is set. The TMR0 interrupt can be masked by clearing the corresponding TMR0 Interrupt Enable bit (T0IE). The TMR0 Interrupt Flag bit (T0IF) is automatically cleared when vectoring to the TMR0 interrupt vector.

11.2 Using Timer0 with External Clock

When the external clock input is used for Timer0, it is synchronized with the internal phase clocks. Figure 11-3 shows the synchronization of the external clock. This synchronization is done after the prescaler. The output of the prescaler (PSOUT) is sampled twice in every instruction cycle to detect a rising or a falling edge. The timing requirements for the external clock are detailed in the electrical specification section for the desired device.

11.2.1 DELAY FROM EXTERNAL CLOCK EDGE

Since the prescaler output is synchronized with the internal clocks, there is a small delay from the time the external clock edge occurs to the time TMR0 is actually incremented. Figure 11-3 shows that this delay is between 3TOSC and 7TOSC. Thus, for example, measuring the interval between two edges (e.g. period) will be accurate within $\pm 4TOSC$ (± 121 ns @ 33 MHz).

FIGURE 11-2: TIMER0 MODULE BLOCK DIAGRAM

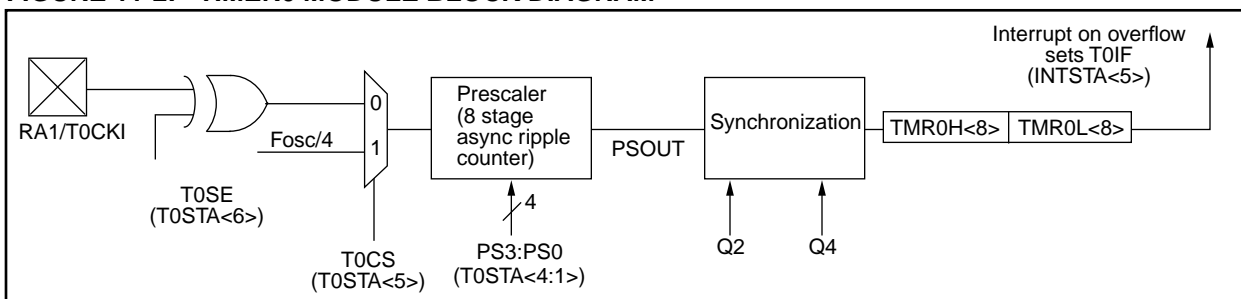
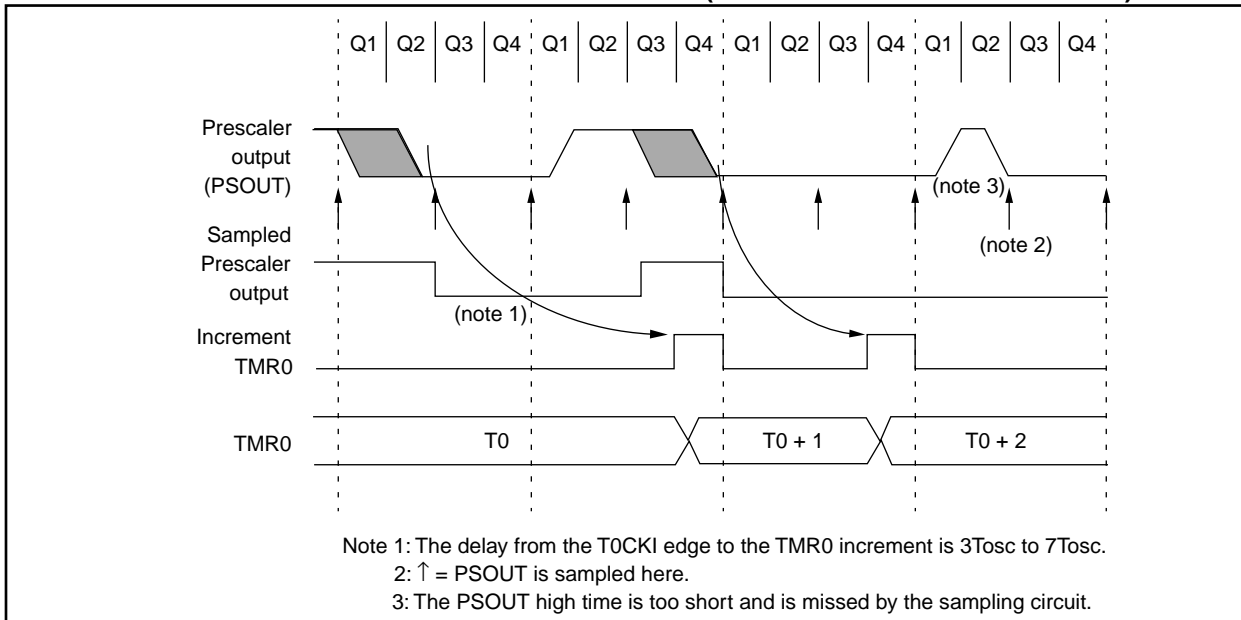


FIGURE 11-3: TMR0 TIMING WITH EXTERNAL CLOCK (INCREMENT ON FALLING EDGE)



ADDWFC		ADD WREG and Carry bit to f						
Syntax:	[<i>label</i>] ADDWFC f,d							
Operands:	$0 \leq f \leq 255$ $d \in [0,1]$							
Operation:	$(WREG) + (f) + C \rightarrow (dest)$							
Status Affected:	OV, C, DC, Z							
Encoding:	<table border="1"><tr><td>0001</td><td>000d</td><td>ffff</td><td>ffff</td></tr></table>				0001	000d	ffff	ffff
0001	000d	ffff	ffff					
Description:	Add WREG, the Carry Flag and data memory location 'f'. If 'd' is 0, the result is placed in WREG. If 'd' is 1, the result is placed in data memory location 'f'.							
Words:	1							
Cycles:	1							
Q Cycle Activity:								
	Q1	Q2	Q3	Q4				
	Decode	Read register 'f'	Execute	Write to destination				

Example: ADDWFC REG 0

Before Instruction

Carry bit = 1
REG = 0x02
WREG = 0x4D

After Instruction

Carry bit = 0
REG = 0x02
WREG = 0x50

ANDLW		And Literal with WREG						
Syntax:	[<i>label</i>] ANDLW k							
Operands:	0 ≤ k ≤ 255							
Operation:	(WREG) .AND. (k) → (WREG)							
Status Affected:	Z							
Encoding:	<table border="1"><tr><td>1011</td><td>0101</td><td>kkkk</td><td>kkkk</td></tr></table>				1011	0101	kkkk	kkkk
1011	0101	kkkk	kkkk					
Description:	The contents of WREG are AND'd with the 8-bit literal 'k'. The result is placed in WREG.							
Words:	1							
Cycles:	1							
Q Cycle Activity:								
	Q1	Q2	Q3	Q4				
	Decode	Read literal 'k'	Execute	Write to WREG				

Example: ANDLW 0x5F

Before Instruction

WREG = 0xA3

After Instruction

WREG = 0x03

ANDWF

AND WREG with f

Syntax:

[/label] ANDWF f,d

Operands:

$0 \leq f \leq 255$

$d \in [0,1]$

Operation:

(WREG) .AND. (f) → (dest)

Status Affected:

Z

Encoding:

0000	101d	ffff	ffff
------	------	------	------

Description:

The contents of WREG are AND'ed with register 'f'. If 'd' is 0 the result is stored in WREG. If 'd' is 1 the result is stored back in register 'f'.

Words:

1

Cycles:

1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Execute	Write to destination

Example: ANDWF REG, 1

Before Instruction

WREG = 0x17

REG = 0xC2

After Instruction

WREG = 0x17

REG = 0x02

BCF

Bit Clear f

Syntax:

[/label] BCF f,b

Operands:

$0 \leq f \leq 255$

$0 \leq b \leq 7$

Operation:

$0 \rightarrow (f)$

Status Affected:

None

Encoding:

1000	1bbb	ffff	ffff
------	------	------	------

Description:

Bit 'b' in register 'f' is cleared.

Words:

1

Cycles:

1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Execute	Write register 'f'

Example: BCF FLAG_REG, 7

Before Instruction

FLAG_REG = 0xC7

After Instruction

FLAG_REG = 0x47

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DCFSNZ Decrement f, skip if not 0

Syntax: `[label] DCFSNZ f,d`

Operands: $0 \leq f \leq 255$
 $d \in [0,1]$

Operation: $(f) - 1 \rightarrow (\text{dest})$;
 skip if not 0

Status Affected: None

Encoding:

0010	011d	ffff	ffff
------	------	------	------

Description: The contents of register 'f' are decremented. If 'd' is 0 the result is placed in WREG. If 'd' is 1 the result is placed back in register 'f'.
 If the result is not 0, the next instruction, which is already fetched, is discarded, and an NOP is executed instead making it a two-cycle instruction.

Words: 1

Cycles: 1(2)

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Execute	Write to destination

If skip:

Q1	Q2	Q3	Q4
Forced NOP	NOP	Execute	NOP

Example:

```

HERE    DCFSNZ  TEMP, 1
ZERO    :
NZERO   :
```

Before Instruction

TEMP_VALUE = ?

After Instruction

```

TEMP_VALUE = TEMP_VALUE - 1,
If TEMP_VALUE = 0;
  PC = Address ( ZERO )
If TEMP_VALUE ≠ 0;
  PC = Address ( NZERO )
```

GOTO Unconditional Branch

Syntax: `[label] GOTO k`

Operands: $0 \leq k \leq 8191$

Operation: $k \rightarrow PC<12:0>$;
 $k<12:8> \rightarrow PCLATH<4:0>$;
 $PC<15:13> \rightarrow PCLATH<7:5>$

Status Affected: None

Encoding:

110k	kkkk	kkkk	kkkk
------	------	------	------

Description: GOTO allows an unconditional branch anywhere within an 8K page boundary. The thirteen bit immediate value is loaded into PC bits <12:0>. Then the upper eight bits of PC are loaded into PCLATH. GOTO is always a two-cycle instruction.

Words: 1

Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'k'<7:0>	Execute	NOP
Forced NOP	NOP	Execute	NOP

Example: GOTO THERE

After Instruction

PC = Address (THERE)

16.0 DEVELOPMENT SUPPORT

16.1 Development Tools

The PIC16/17 microcontrollers are supported with a full range of hardware and software development tools:

- PICMASTER/PICMASTER CE Real-Time In-Circuit Emulator
- ICEPIC Low-Cost PIC16C5X and PIC16CXXX In-Circuit Emulator
- PRO MATE® II Universal Programmer
- PICSTART® Plus Entry-Level Prototype Programmer
- PICDEM-1 Low-Cost Demonstration Board
- PICDEM-2 Low-Cost Demonstration Board
- PICDEM-3 Low-Cost Demonstration Board
- MPASM Assembler
- MPLAB-SIM Software Simulator
- MPLAB-C (C Compiler)
- Fuzzy logic development system (fuzzyTECH®-MP)

16.2 PICMASTER: High Performance Universal In-Circuit Emulator with MPLAB IDE

The PICMASTER Universal In-Circuit Emulator is intended to provide the product development engineer with a complete microcontroller design tool set for all microcontrollers in the PIC12C5XX, PIC14000, PIC16C5X, PIC16CXXX and PIC17CXX families. PICMASTER is supplied with the MPLAB™ Integrated Development Environment (IDE), which allows editing, "make" and download, and source debugging from a single environment.

Interchangeable target probes allow the system to be easily reconfigured for emulation of different processors. The universal architecture of the PICMASTER allows expansion to support all new Microchip microcontrollers.

The PICMASTER Emulator System has been designed as a real-time emulation system with advanced features that are generally found on more expensive development tools. The PC compatible 386 (and higher) machine platform and Microsoft Windows® 3.x environment were chosen to best make these features available to you, the end user.

A CE compliant version of PICMASTER is available for European Union (EU) countries.

16.3 ICEPIC: Low-cost PIC16CXXX In-Circuit Emulator

ICEPIC is a low-cost in-circuit emulator solution for the Microchip PIC16C5X and PIC16CXXX families of 8-bit OTP microcontrollers.

ICEPIC is designed to operate on PC-compatible machines ranging from 286-AT® through Pentium™ based machines under Windows 3.x environment. ICEPIC features real time, non-intrusive emulation.

16.4 PRO MATE II: Universal Programmer

The PRO MATE II Universal Programmer is a full-featured programmer capable of operating in stand-alone mode as well as PC-hosted mode.

The PRO MATE II has programmable VDD and VPP supplies which allows it to verify programmed memory at VDD min and VDD max for maximum reliability. It has an LCD display for displaying error messages, keys to enter commands and a modular detachable socket assembly to support various package types. In stand-alone mode the PRO MATE II can read, verify or program PIC16C5X, PIC16CXXX, PIC17CXX and PIC14000 devices. It can also set configuration and code-protect bits in this mode.

16.5 PICSTART Plus Entry Level Development System

The PICSTART programmer is an easy-to-use, low-cost prototype programmer. It connects to the PC via one of the COM (RS-232) ports. MPLAB Integrated Development Environment software makes using the programmer simple and efficient. PICSTART Plus is not recommended for production programming.

PICSTART Plus supports all PIC12C5XX, PIC14000, PIC16C5X, PIC16CXXX and PIC17CXX devices with up to 40 pins. Larger pin count devices such as the PIC16C923 and PIC16C924 may be supported with an adapter socket.

FIGURE 17-11: MEMORY INTERFACE WRITE TIMING

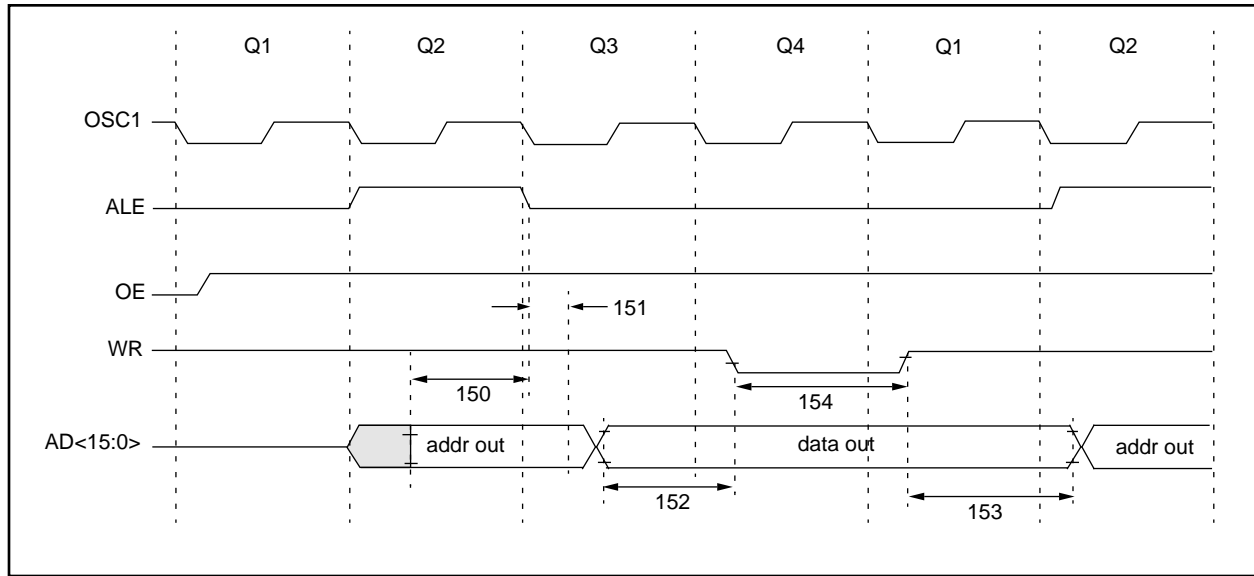


TABLE 17-11: MEMORY INTERFACE WRITE REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
150	TadV2aLL	AD<15:0> (address) valid to ALE↓ (address setup time)	0.25Tcy - 30	—	—	ns	
151	TaLL2adL	ALE↓ to address out invalid (address hold time)	0	—	—	ns	
152	TadV2wrL	Data out valid to WR↓ (data setup time)	0.25Tcy - 40	—	—	ns	
153	TwrH2adL	WR↑ to data out invalid (data hold time)	—	0.25Tcy §	—	ns	
154	TwrL	WR pulse width	—	0.25Tcy §	—	ns	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

§ This specification is guaranteed by design.

PIC17C4X

Applicable Devices 42 R42 42A 43 R43 44

FIGURE 18-13: WDT TIMER TIME-OUT PERIOD vs. VDD

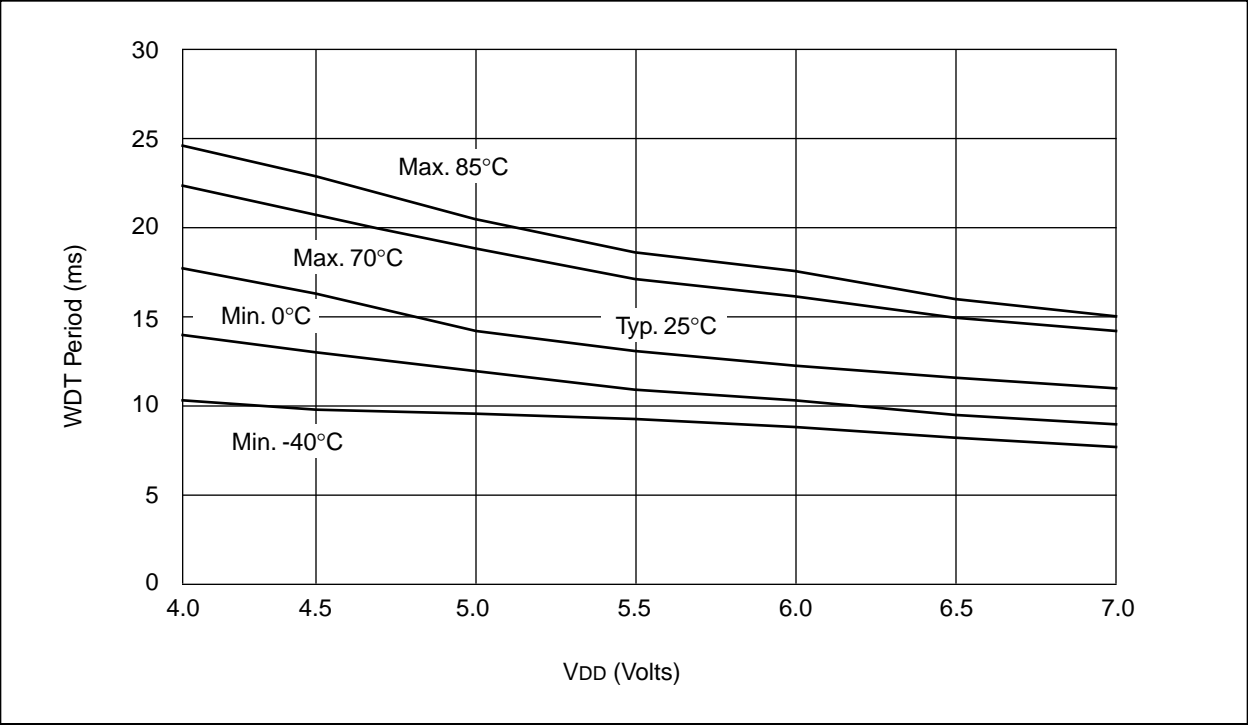


FIGURE 18-14: IOH vs. VOH, VDD = 3V

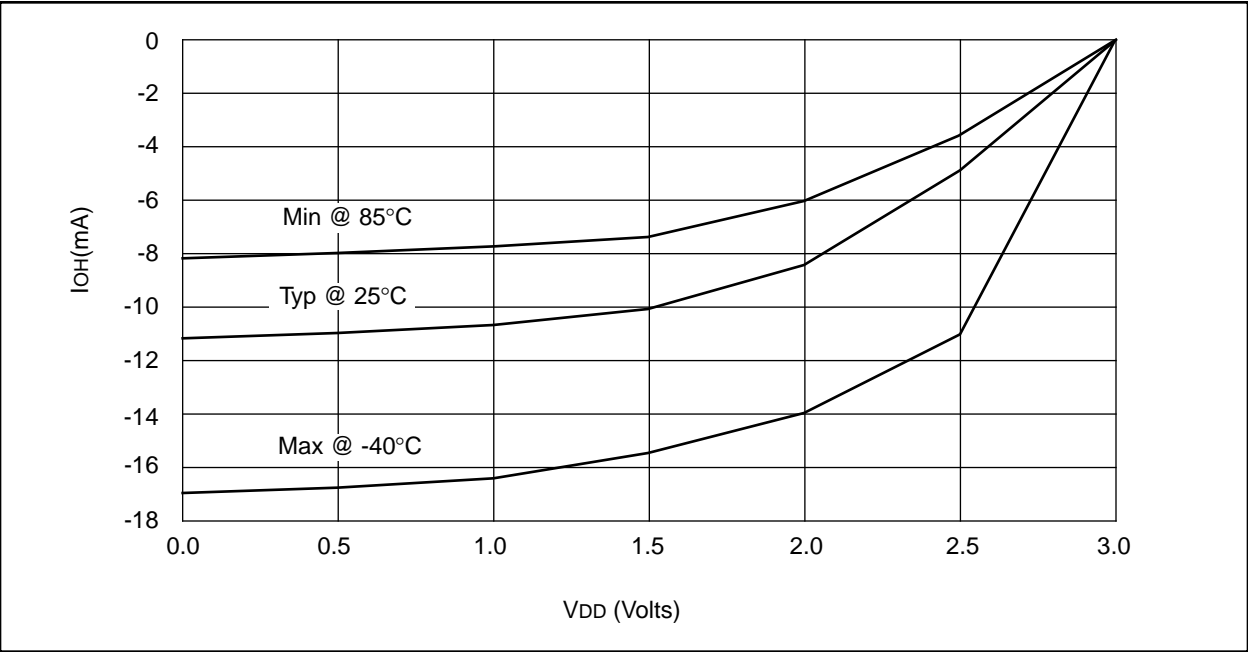


FIGURE 18-19: V_{IH} , V_{IL} of I/O PINS (SCHMITT TRIGGER) vs. V_{DD}

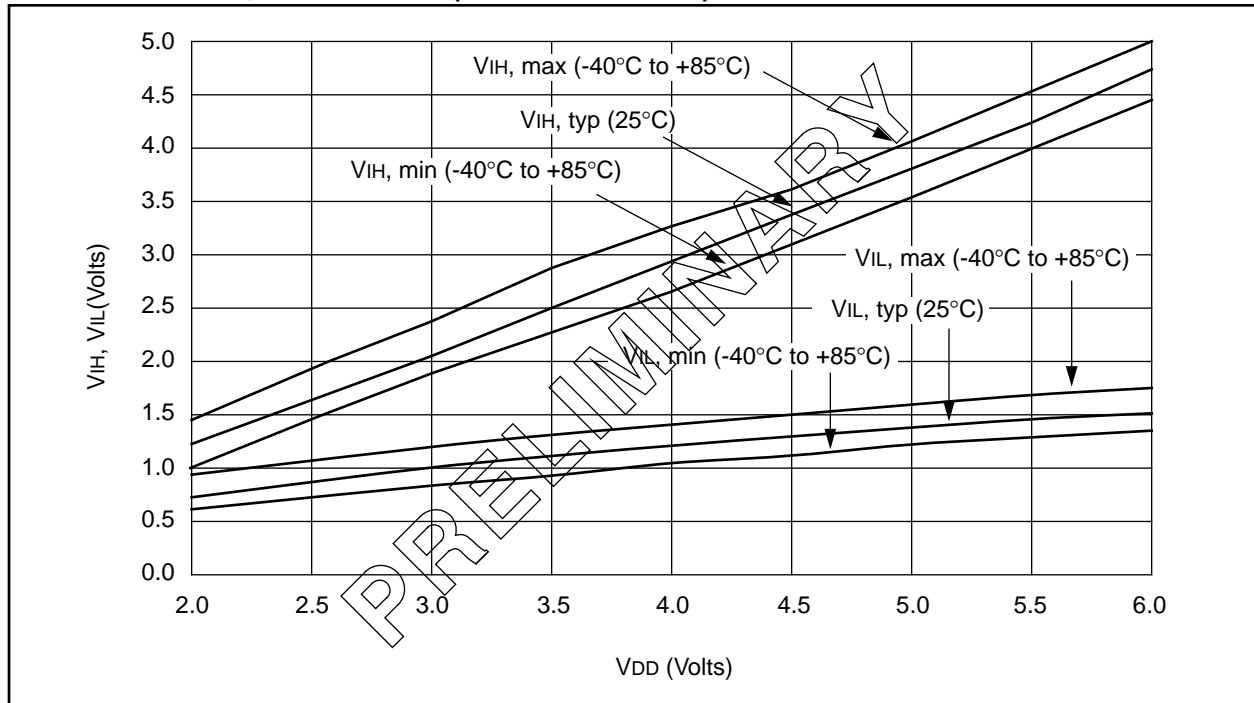
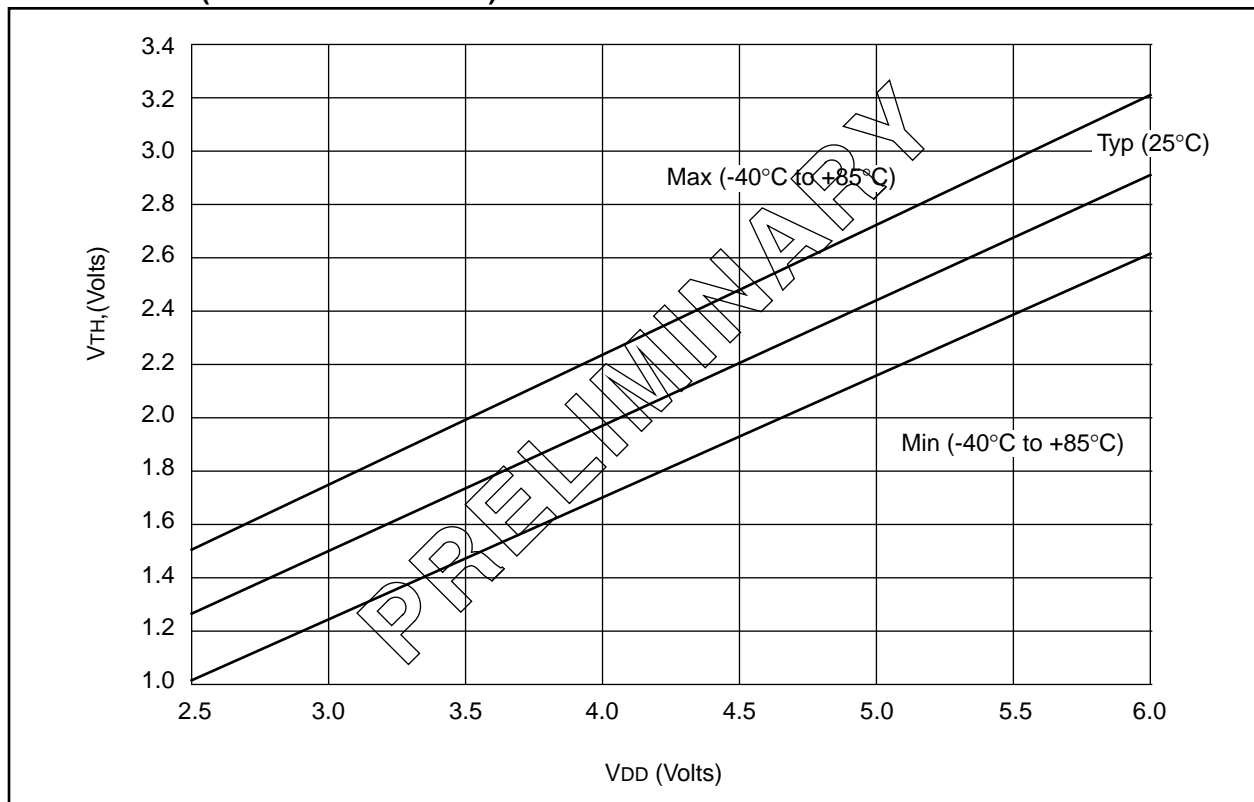


FIGURE 18-20: V_{TH} (INPUT THRESHOLD VOLTAGE) OF OSC1 INPUT (IN XT AND LF MODES) vs. V_{DD}



19.3 DC CHARACTERISTICS: **PIC17CR42/42A/43/R43/44-16 (Commercial, Industrial)**
PIC17CR42/42A/43/R43/44-25 (Commercial, Industrial)
PIC17CR42/42A/43/R43/44-33 (Commercial, Industrial)
PIC17LCR42/42A/43/R43/44-08 (Commercial, Industrial)

DC CHARACTERISTICS <div> Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial and $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial Operating voltage V_{DD} range as described in Section 19.1 </div>							
Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
D030	V_{IL}	Input Low Voltage					
		I/O ports					
		with TTL buffer	V_{SS}	–	0.8	V	$4.5\text{V} \leq V_{DD} \leq 5.5\text{V}$
		with Schmitt Trigger buffer	V_{SS}	–	$0.2V_{DD}$	V	$2.5\text{V} \leq V_{DD} \leq 4.5\text{V}$
D031			V_{SS}	–	$0.2V_{DD}$	V	
D032		$\overline{\text{MCLR}}$, OSC1 (in EC and RC mode)	V_{SS}	–	$0.2V_{DD}$	V	Note1
D033		OSC1 (in XT, and LF mode)	–	$0.5V_{DD}$	–	V	
D040	V_{IH}	Input High Voltage					
		I/O ports					
		with TTL buffer	2.0	–	V_{DD}	V	$4.5\text{V} \leq V_{DD} \leq 5.5\text{V}$
		with Schmitt Trigger buffer	$1 + 0.2V_{DD}$	–	V_{DD}	V	$2.5\text{V} \leq V_{DD} \leq 4.5\text{V}$
			$0.8V_{DD}$	–	V_{DD}	V	
D041			$0.8V_{DD}$	–	V_{DD}	V	
D042		$\overline{\text{MCLR}}$	$0.8V_{DD}$	–	V_{DD}	V	Note1
D043		OSC1 (XT, and LF mode)	–	$0.5V_{DD}$	–	V	
D050	V_{HYS}	Hysteresis of Schmitt Trigger inputs	$0.15V_{DD}^*$	–	–	V	
D060	I_{IL}	Input Leakage Current (Notes 2, 3)					
		I/O ports (except RA2, RA3)	–	–	± 1	μA	$V_{SS} \leq V_{PIN} \leq V_{DD}$, I/O Pin at hi-impedance PORTB weak pull-ups disabled
		$\overline{\text{MCLR}}$	–	–	± 2	μA	$V_{PIN} = V_{SS}$ or $V_{PIN} = V_{DD}$
		RA2, RA3	–	–	± 2	μA	$V_{SS} \leq V_{RA2}, V_{RA3} \leq 12\text{V}$
		OSC1, TEST (EC, RC modes)	–	–	± 1	μA	$V_{SS} \leq V_{PIN} \leq V_{DD}$
		OSC1, TEST (XT, LF modes)	–	–	V_{PIN}	μA	$R_F \geq 1\text{ M}\Omega$, see Figure 14.2
		$\overline{\text{MCLR}}$	–	–	10	μA	$V_{MCLR} = V_{PP} = 12\text{V}$ (when not programming)
D070	I_{PURB}	PORTB weak pull-up current	60	200	400	μA	$V_{PIN} = V_{SS}$, $\overline{\text{RBP}} = 0$ $4.5\text{V} \leq V_{DD} \leq 6.0\text{V}$

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

‡ These parameters are for design guidance only and are not tested, nor characterized.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC17CXX devices be driven with external clock in RC mode.

2: The leakage current on the $\overline{\text{MCLR}}$ pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as coming out of the pin.

4: These specifications are for the programming of the on-chip program memory EPROM through the use of the table write instructions. The complete programming specifications can be found in: PIC17CXX Programming Specifications (Literature number DS30139).

5: The $\overline{\text{MCLR}}/V_{PP}$ pin may be kept in this range at times other than programming, but is not recommended.

6: For TTL buffers, the better of the two specifications may be used.

FIGURE 19-5: TIMER0 CLOCK TIMINGS

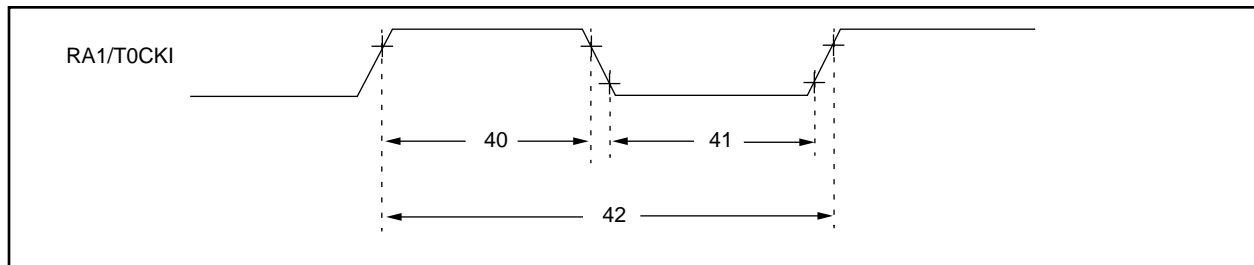


TABLE 19-5: TIMER0 CLOCK REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
40	Tt0H	T0CKI High Pulse Width	No Prescaler	0.5Tcy + 20 §	—	—	ns
		With Prescaler	10*	—	—	ns	
41	Tt0L	T0CKI Low Pulse Width	No Prescaler	0.5Tcy + 20 §	—	—	ns
		With Prescaler	10*	—	—	ns	
42	Tt0P	T0CKI Period	Greater of: 20 ns or $\frac{Tcy + 40 §}{N}$	—	—	ns	N = prescale value (1, 2, 4, ..., 256)

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

§ This specification ensured by design.

FIGURE 19-6: TIMER1, TIMER2, AND TIMER3 CLOCK TIMINGS

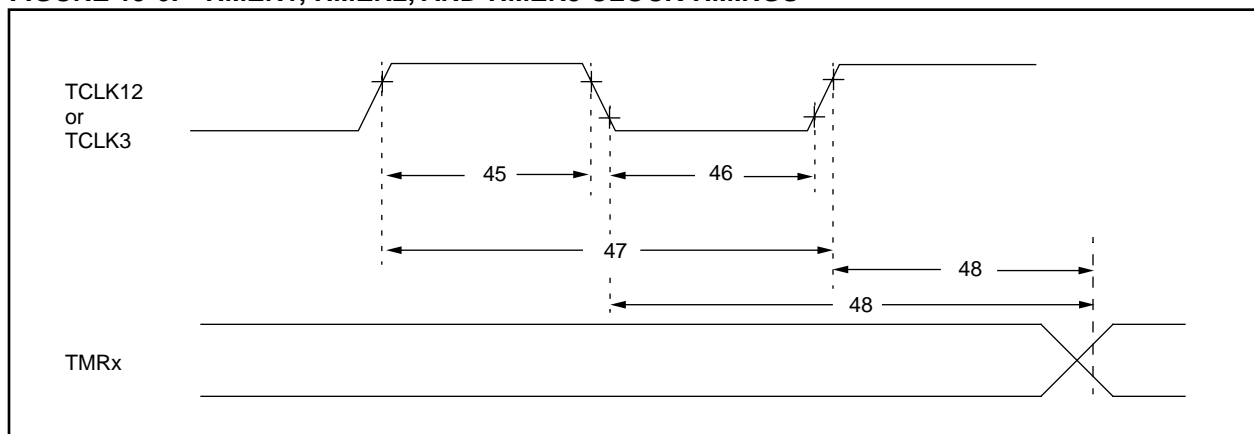


TABLE 19-6: TIMER1, TIMER2, AND TIMER3 CLOCK REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
45	Tt123H	TCLK12 and TCLK3 high time	0.5Tcy + 20 §	—	—	ns	
46	Tt123L	TCLK12 and TCLK3 low time	0.5Tcy + 20 §	—	—	ns	
47	Tt123P	TCLK12 and TCLK3 input period	$\frac{Tcy + 40 §}{N}$	—	—	ns	N = prescale value (1, 2, 4, 8)
48	TckE2tmr1	Delay from selected External Clock Edge to Timer increment	2Tosc §		6Tosc §		

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

§ This specification ensured by design.

FIGURE 20-7: TYPICAL I_{DD} vs. FREQUENCY (EXTERNAL CLOCK 25°C)

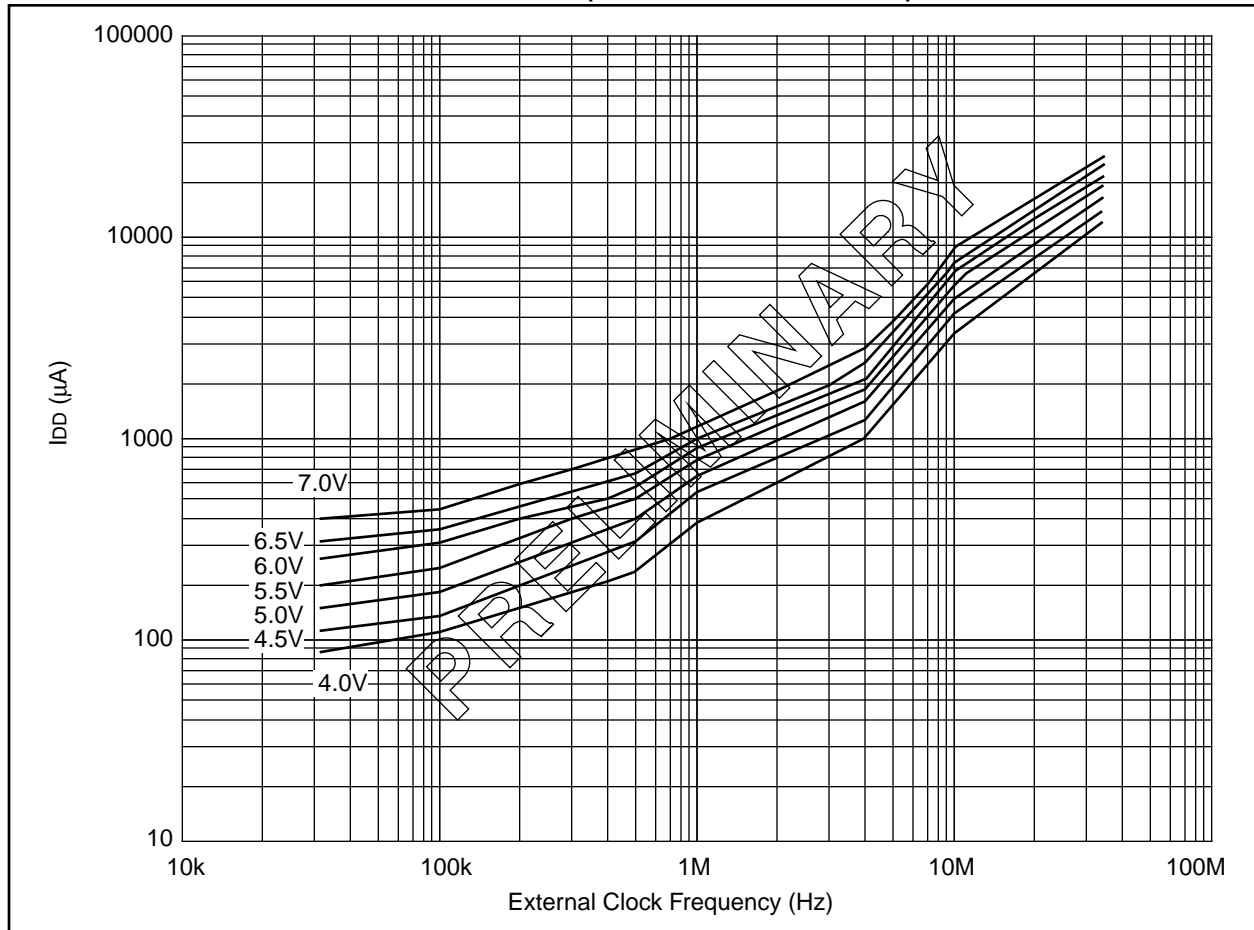
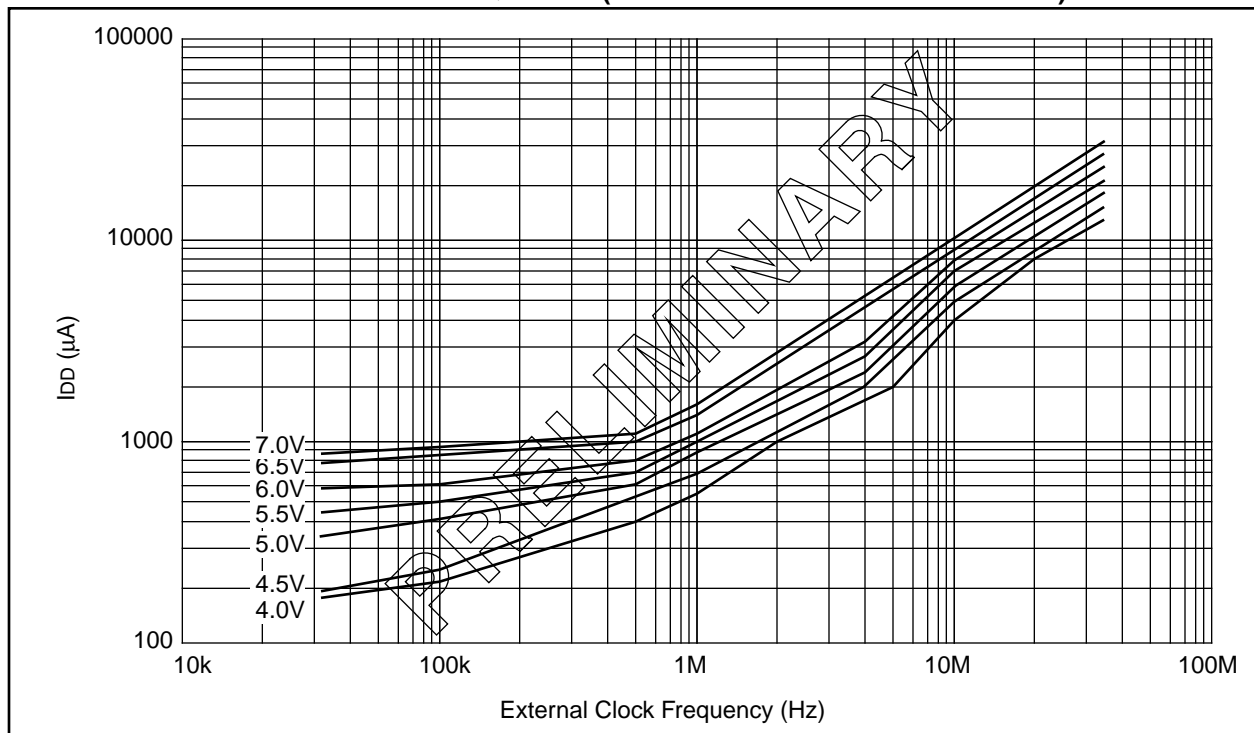
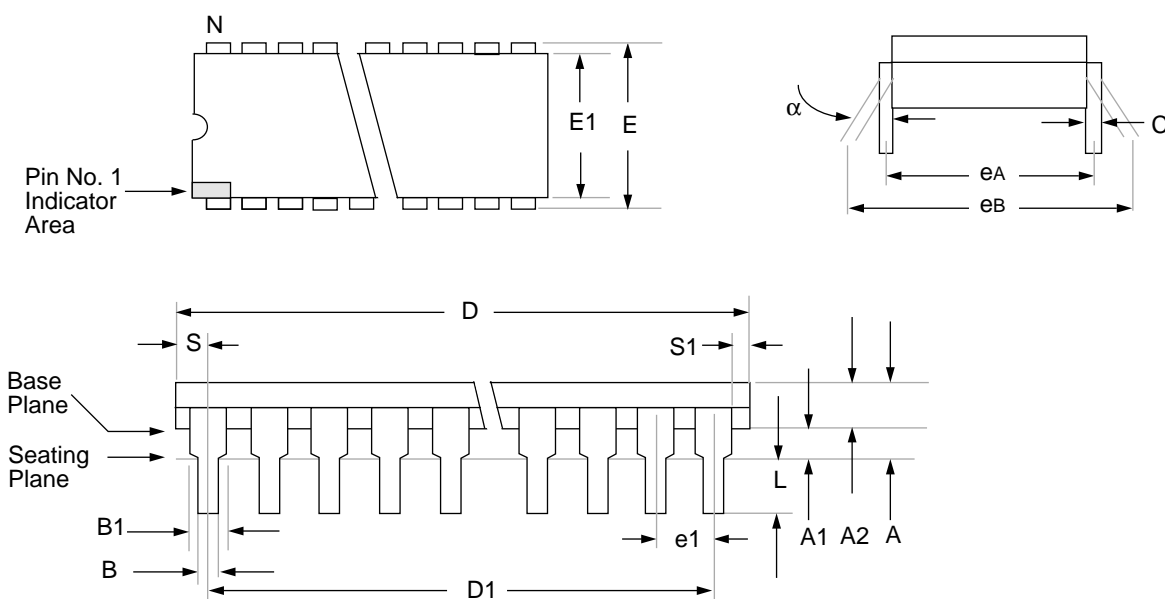


FIGURE 20-8: MAXIMUM I_{DD} vs. FREQUENCY (EXTERNAL CLOCK 125°C TO -40°C)



PIC17C4X

21.2 40-Lead Plastic Dual In-line (600 mil)



Package Group: Plastic Dual In-Line (PLA)						
Symbol	Millimeters			Inches		
	Min	Max	Notes	Min	Max	Notes
α	0°	10°		0°	10°	
A	—	5.080		—	0.200	
A1	0.381	—		0.015	—	
A2	3.175	4.064		0.125	0.160	
B	0.355	0.559		0.014	0.022	
B1	1.270	1.778	Typical	0.050	0.070	Typical
C	0.203	0.381	Typical	0.008	0.015	Typical
D	51.181	52.197		2.015	2.055	
D1	48.260	48.260	Reference	1.900	1.900	Reference
E	15.240	15.875		0.600	0.625	
E1	13.462	13.970		0.530	0.550	
e1	2.489	2.591	Typical	0.098	0.102	Typical
eA	15.240	15.240	Reference	0.600	0.600	Reference
eB	15.240	17.272		0.600	0.680	
L	2.921	3.683		0.115	0.145	
N	40	40		40	40	
S	1.270	—		0.050	—	
S1	0.508	—		0.020	—	

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PIC17C4X Product Identification System

To order or to obtain information, e.g., on pricing or delivery, please use the listed part numbers, and refer to the factory or the listed sales offices.

PART NO. – XX X /XX XXX					Examples	
					a) PIC17C42 – 16/P Commercial Temp., PDIP package, 16 MHz, normal VDD limits	b) PIC17LC44 – 08/PT Commercial Temp., TQFP package, 8MHz, extended VDD limits
				Pattern:		
				Package:		
				Temperature Range:		
				Frequency Range:		
				Device:	c) PIC17C43 – 25I/P Industrial Temp., PDIP package, 25 MHz, normal VDD limits	

Sales and Support

Products supported by a preliminary Data Sheet may possibly have an errata sheet describing minor operational differences and recommended workarounds. To determine if an errata sheet exists for a particular device, please contact one of the following:

1. Your local Microchip sales office (see below)
2. The Microchip Corporate Literature Center U.S. FAX: (602) 786-7277
3. The Microchip's Bulletin Board, via your local CompuServe number (CompuServe membership NOT required).

Please specify which device, revision of silicon and Data Sheet (include Literature #) you are using.

For latest version information and upgrade kits for Microchip Development Tools, please call 1-800-755-2345 or 1-602-786-7302.